

# LMH5401EVM Evaluation Module (EVM)

The LMH5401EVM is an evaluation module for the single LMH5401 amplifier in a 14-lead high-performance RF package. This evaluation module is designed to quickly and easily demonstrate the functionality and versatility of the amplifier. The EVM is ready to connect to power, signal source, and test instruments through the use of onboard connectors. The EVM comes configured for easy connection with common  $50-\Omega$  laboratory equipment on its inputs and outputs. The amplifier is configured for single-ended input with gain of 12 dB (4 V/V). The board has differential outputs, one for each of the amplifier outputs. It can be easily configured for differential inputs, and single- or split-supply operation.

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### 1 Features

- · Configured for split-supply operation and easily modified for single supply
- · Single ended or differential input signals
- · Fully differential output
- Designed for easy connection to standard 50-Ω input/output impedance test equipment
- · Inputs and outputs include SMA connectors



Figure 1. LMH5401EVM Board

# 2 EVM Specifications

	PARAMETER	VALUE
$V_S$	Single-supply voltage range (V- = ground)	3.15 V to 5.25 V
$V_S\pm$	Split-supply voltage range	±1.58 V to ±2.625 V
GND	Ground reference pins	$(V+-2 \ V)$ to $V-$
PD	Power down (PD) input voltage	GND to Vcc
I <sub>S</sub> ±	Supply current	58 mA
I <sub>IN</sub>	Input voltage	V <sub>S</sub> ±, Max
$I_{\text{OUT}}$	Output drive	±40 mA



www.ti.com Power Connections

### 3 Power Connections

The LMH5401EVM is equipped with test loops for easy connection of power. The positive supply input is red and is labeled V+. The negative supply input is yellow and is labeled V-. Ground is black and is labeled GND.

### 3.1 Split-Supply Operation

To operate as split supply, apply the positive supply voltage to V+, negative supply voltage to V-, and the ground reference from supply to GND. The supply voltages do not need to be symmetrical, provided that the total supply voltage is between 3.15 V and 5.25 V, any combination of positive and negative supply voltages is acceptable. This feature is often used when the output common mode voltage must be set to a particular value. For best performance, the power supply voltages should be symmetrical around the desired output common-mode voltage.

### 3.2 Single-Supply Operation

To operate as single supply, connect jumper V– to GND, and apply the positive supply voltage to V+. Inputs and outputs must be biased as in the LMH5401 datasheet (<u>SBOS710</u>) specifications for proper operation.

### 4 Input and Output Connections

The LMH5401EVM is equipped with SMA connectors for easy connection of signal generators and analysis equipment. As shipped, the EVM is configured for a gain of 12 dB, split supply, single-ended input and differential outputs each with  $50-\Omega$  termination. For best results, signals must be routed to and from the EVM with cables having  $50-\Omega$  characteristic impedance. The input connectors for single-ended input signals are IN+ and IN- which are symmetrical. The output connectors are OUT+ and OUT-. In addition to the signal cables a  $50-\Omega$  resistive termination is required for the unused input. See the LMH5401 datasheet for additional detail on configuring the device.

### 4.1 CM (Output Common Mode Voltage) Input

The LMH5401 device has an output common-mode control pin that sets the output common mode voltage. The evaluation board is configured with a resistive divider to set the output common mode voltage at the mid supply voltage. If a different output common-mode voltage is specified, the SMA connector can be used to connect an external voltage source. The valid voltage range for the CM pin is approximately  $([V+]-2\ V)$  to  $([V-]+2\ V)$ . See the LMH5401 datasheet for performance curves that show how performance is impacted by an output common mode voltage that is not at the mid-supply voltage.

### 4.2 PD (Power Down) Input

The LMH5401 device has a power-down input pin that allows the amplifier to enter a low-power state when it does not need to be active. The LMH5401 PD pin is referenced to the GND pin. The threshold voltage is 1.1 V. Any voltage over 1.2 V above the ground reference pins will disable the amplifier. Any input below 0.9 V enables the amplifier. Because the PD pin is not referenced to either of the supply pins the same logic level can be used for the PD function regardless of the configuration of the supply voltages. The LMH5401EVM has a jumper (JPD) that allows the amplifier to be manually disabled. In order to facilitate driving the PD pin with a high-speed signal source, the resistor-capacitor combination (Rsd/C9) provides high frequency termination for signals from a 50-Ω pulse generator.

### 4.3 Single-Ended Inputs

The LMH5401 device was designed for use with  $50-\Omega$  single-ended inputs. Even though the board was designed for single-ended inputs, the board is fully symmetrical, so either input can be used. Connect a  $50-\Omega$  signal source to either IN+ or IN- and connect a  $50-\Omega$  SMA termination to the other input. This way both inputs have the same termination condition and the circuit is balanced. In the case where no SMA  $50-\Omega$  termination is available, soldering a  $50-\Omega$  resistor from the unused input signal trace to the ground plane is acceptable. A small section of the ground plane has no solder mask that can be used for this purpose.



### 4.4 Differential Inputs

Using the LMH5401 for differential inputs is possible, however the on chip resistors will need to be changed first. The LMH5401 device has an internal resistance of 25  $\Omega$  between the output and the FB connections. Once the desired value of the Rf resistors is determined reduce them by 25 Ohms. To impedance match a 100- $\Omega$  differential source, the Ri- and R2 resistors both need to be 50  $\Omega$ . The desired gain will then determine the required value for Rf+ and Rf-. The gain will be Av = (Rf +25)/ Rg. As with other RF devices the final, system gain will depend on the source resistance and the load resistance.

### 4.5 Differential Outputs

The LMH5401EVM has two output SMA connectors that are designed to mate to  $50-\Omega$  test equipment. By connecting both outputs to  $50-\Omega$  test equipment, the output load is  $100-\Omega$  differential. With the on chip and on board matching resistors, the total load to the amplifier is  $200~\Omega$ . The matching resistors cause a 6-dB loss in voltage gain. The evaluation board has  $40-\Omega$  resistors on the board because there are  $10-\Omega$  output resistors on chip inside the device.

### 4.6 Single-Ended Outputs

Using an external balun to combine the two differential outputs creates a single-ended signal that can be interfaced to most  $50-\Omega$  test equipment. This is the method used by TI engineers to create the datasheet plots. To match the performance of the LMH5401 device, a very broadband balun must be selected. TI recommends the Marki B0100 or the PicoPulse Labs 5310A baluns.



## 5 LMH5401EVM Schematic, Layout, and Bill of Materials

This section contains the EVM schematic, PCB layouts, and the bill of materials (BOM).

### 5.1 Schematic

Figure 2 illustrates the LMH5401EVM schematic.

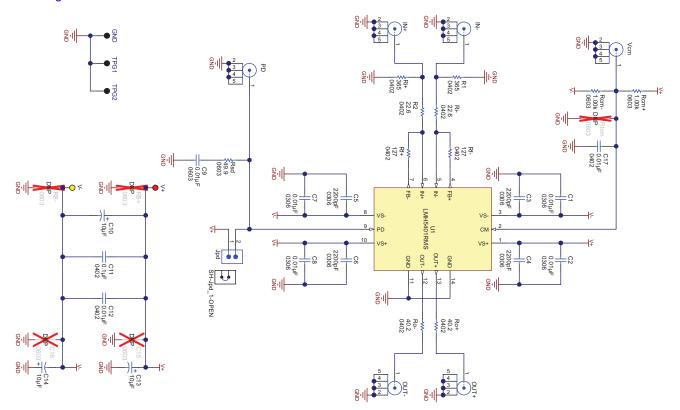


Figure 2. LMH5401EVM Schematic



# 5.2 LMH5401EVM Layers

Figure 3 through Figure 8 show the LMH5401EVM layers.

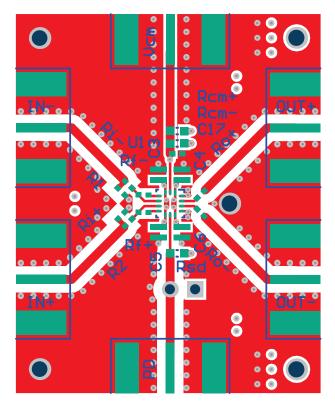


Figure 3. LMH5401EVM Top Layer

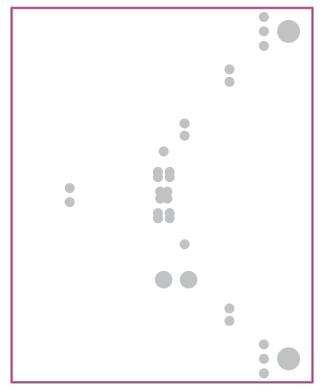


Figure 4. Layer 2



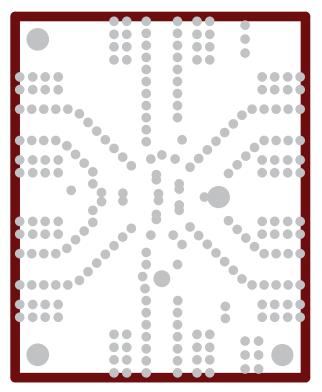


Figure 5. Layer 3

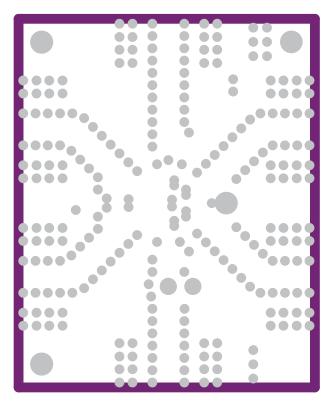


Figure 6. Layer 4



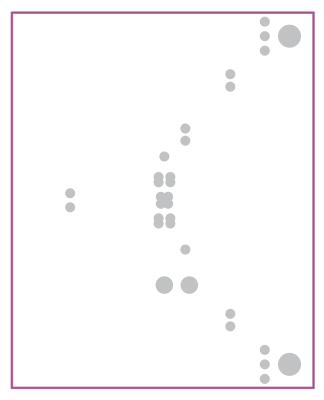


Figure 7. Layer 5

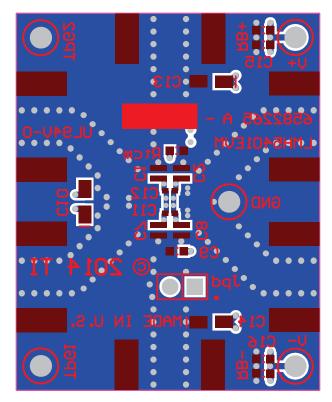


Figure 8. Bottom Layer



#### 5.3 Bill of Materials

Table 1 lists the EVM BOM.

### Table 1. LMH5401EVM Bill of Materials

Item	Designator	Value	Description	Package Reference	Manufacturer	Part Number	Quantity
1	!PCB		Printed Circuit Board		Any	6582265	1
2	C1, C2, C7, C8	0.01uF	CAP, CERM, 0.01uF, 25V, +/-20%, X7R, 0306	0306	MuRata	LLL185R71E103MA01L	4
3	C3, C4, C5, C6	2200pF	CAP, CERM, 2200pF, 50V, +/-20%, X7R, 0306	0306	MuRata	LLL185R71H222MA01L	4
4	C9	0.01uF	CAP, CERM, 0.01uF, 16V, +/-10%, X7R, 0603	0603	MuRata	GRM188R71C103KA01D	1
5	C10, C13, C14	10uF	CAP, TA, 10uF, 10V, +/-10%, 0.9 ohm, SMD	3216-18	AVX	TPSA106K010R0900	3
6	C11	0.1uF	CAP, CERM, 0.1uF, 10V, +/-10%, X5R, 0402	0402	TDK	C1005X5R1A104K	1
7	C12, C17	0.01uF	CAP, CERM, 0.01uF, 25V, +/-10%, X7R, 0402	0402	TDK	C1005X7R1E103K	2
8	GND, TPG1, TPG2	Black	Test Point, TH, Multipurpose, Black		Keystone Electronics	5011	3
9	IN+, IN-, OUT+, OUT-, PD, Vcm		Connector, SMT, End launch SMA 50 ohm	SMA End Launch	Emerson Network Power	142-0701-851	6
10	Jpd		Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator	TSW-102-07-G-S	Samtec, Inc.	TSW-102-07-G-S	1
11	R1, Ri+	365	RES, 365, 1%, 0.063 W, 0402	0402	Vishay-Dale	CRCW0402365RFKED	2
12	R2, Ri-	22.6	RES, 22.6, 1%, 0.063 W, 0402	0402	Vishay-Dale	CRCW040222R6FKED	2
13	Rcm+, Rcm-	1.00k	RES, 1.00k ohm, 1%, 0.1W, 0603	0603	Vishay-Dale	CRCW06031K00FKEA	2
14	Rf+, Rf-	127	RES, 127, 1%, 0.063 W, 0402	0402	Vishay-Dale	CRCW0402127RFKED	2
15	Ro+, Ro-	40.2	RES, 40.2 ohm, 1%, 0.063W, 0402	0402	Vishay-Dale	CRCW040240R2FKED	2
16	Rsd	49.9	RES, 49.9 ohm, 1%, 0.1W, 0603	0603	Vishay-Dale	CRCW060349R9FKEA	1
17	SH-Jpd_1-OPEN	1x2	Shunt, 100mil, Gold plated, Black		AMP	382811-6	1
18	U1		8GHz Ultra Wideband Fully Differential Amplifier, RMS0014A	RMS0014A	Texas Instruments	LMH5401RMS	1
19	V+	Red	Test Point, TH, Multipurpose, Red		Keystone Electronics	5010	1
20	V-	Yellow	Test Point, Multipurpose, Yellow, TH	Yellow Multipurpose Testpoint	Keystone	5014	1
21	C15, C16		CAP, CERM, xxxF, xxV, [TempCo], xx%, [PackageReference]	0603	Used in BOM report	Used in BOM report	0
22	RB+, RB-, Rtcm		RES, xxx ohm, x%, xW, [PackageReference]	0603	Used in BOM report	Used in BOM report	0



Revision History www.ti.com

# **Revision History**

Changes from Original (October 2014) to A Revision				
•	Corrected Value column in Table 1: moved all entries down by one row	9		

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### STANDARD TERMS AND CONDITIONS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.
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  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
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  - 2.3 If any EVM fails to conform to the warranty set forth above, Tl's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC - FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### **CAUTION**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

#### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

#### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see <a href="http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page">http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page</a> 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
  http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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  - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
  - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
  - 4.3 Safety-Related Warnings and Restrictions:
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    - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
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